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# Force-Sense Switches

### **Features**

- 6Ω Force Signal Paths (±15V Supplies)
  1Ω Force Signal Matching (±15V Supplies)
- 60Ω Sense-Guard Signal Paths (±15V Supplies)
  8Ω Sense-Guard Signal Matching (±15V Supplies)
- ♦ Rail-to-Rail Signal Handling
- Break-Before-Make Switching (MAX4556)
- ton and toff = 275ns (±15V Supplies)
- Low 1µA Power Consumption
- >2kV ESD Protection per Method 3015.7
- TTL/CMOS-Compatible Inputs

### Ordering Information

Maxim Integrated Products 1

PART	TEMP. RANGE	PIN-PACKAGE
MAX4554CPE	0°C to +70°C	16 Plastic DIP
MAX4554CSE	0°C to +70°C	16 Narrow SO
MAX4554C/D	0°C to +70°C	Dice*
MAX4554EPE	-40°C to +85°C	16 Plastic DIP
MAX4554ESE	-40°C to +85°C	16 Narrow SO

Ordering Information continued at end of data sheet. \*Contact factory for availability.

Rail-to-Rail is a registered trademark of Nippon Motorola Ltd.

# **General Description**

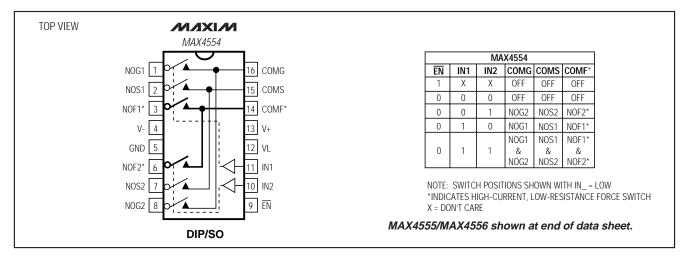
The MAX4554/MAX4555/MAX4556 are CMOS analog ICs configured as force-sense switches for Kelvin sensing in automated test equipment (ATE). Each part contains high-current, low-resistance switches for forcing current, and higher resistance switches for sensing a voltage or switching guard signals. The MAX4554 contains two force switches, two sense switches, and two guard switches configured as two triple-pole/single-throw (3PST) normally open (NO) switches. The MAX4555 contains four independent single-pole/single-throw (SPST) normally closed (NC) switches, two force switches, and two sense switches. The MAX4556 contains three independent single-pole/single-throw (SPST) normally closed (NC) switches, two force switches, and two sense switches. The MAX4556 contains three independent single-pole/double-throw (SPDT) switches, of which one is a force switch and two are sense switches.

These devices operate from a single supply of +9V to +40V or dual supplies of  $\pm 4.5V$  to  $\pm 20V$ . On-resistance (6 $\Omega$  max) is matched between switches to  $1\Omega$  max. Each switch can handle Rail-to-Rail<sup>®</sup> analog signals. The off-leakage current is only 0.25nA at +25°C and 2.5nA at +85°C. The MAX4554 is also fully specified for +20V and -10V operation.

All digital inputs have +0.8V and +2.4V logic thresholds, ensuring both TTL- and CMOS-logic compatibility.

### **Applications**

Automated Test Equipment (ATE) Calibrators Precision Power Supplies Automatic Calibration Circuits Asymmetric Digital Subscriber Line (ADSL) with Loopback **Pin Confi** 



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For free samples & the latest literature: http://www.maxim-ic.com, or phone 1-800-998-8800. For small orders, phone 408-737-7600 ext. 3468.

### \_Pin Configurations/Functional Diagrams/Truth Tables

# **ABSOLUTE MAXIMUM RATINGS**

(Voltages referenced to GND)

(	
V+0.3V to +44V	ESD per Method 3015.7>2000V
V25V to +0.3V	Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
V+ to V0.3V to +44V	Plastic DIP (derate 10.53mW/°C above +70°C)842mW
All Other Pins (Note 1)(V 0.3V) to (V+ + 0.3V)	Narrow SO (derate 8.7mW/°C above +70°C)
Continuous Current into Force Terminals	Operating Temperature Ranges
Continuous Current into Any Other Terminal±30mA	MAX455_C_E0°C to +70°C
Peak Current into Force Terminals	MAX455_E_ E40°C to +85°C
(pulsed at 1ms, 10% duty cycle)±300mA	Storage Temperature Range65°C to +150°C
Peak Current into Any Other Terminal	Lead Temperature (soldering, 10sec)+300°C
(pulsed at 1ms, 10% duty cycle)±100mA	

Note 1: Signals on analog or digital pins exceeding V+ or V- are clamped by internal diodes. Limit forward diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# ELECTRICAL CHARACTERISTICS—MAX4554 (+20V, -10V Supplies)

(V+ = +20V, V- = -10V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
$6\Omega$ ANALOG SWITCH (FOR	CE)						1
Analog Signal Range	Vcomf, Vnof_	(Note 3)	C, E	V-		V+	V
On-Resistance	Ron	$V_{COMF} = 10V$ , $I_{COMF} = 10mA$	+25°C		3.5	6	Ω
UII-RESISIONCE	KON	VCOMF = TOV, TCOMF = TOTTA	С, Е			7	
On-Resistance Match	ΔRon	VCOME = 10V, ICOME = 10mA	+25°C		0.4	1	Ω
(Note 4)	ARON		С, Е			1.5	1.5
On-Resistance Flatness		$V_{COMF} = +5V, 0V, -5V;$	+25°C		0.5	1.5	Ω
(Note 5)	Rflat(on)	$I_{COMF} = 10 \text{mA}$	С, Е			2.0	
NOF_ Off-Leakage Current		V+ = 22V, V- = -11V,	+25°C	-0.25	0.03	0.25	0.25 nA
NOF_ OII-Leakage Current	INOF_(OFF)	$V_{COMF} = \pm 10V, V_{NOF} = \mp 10V$	С, Е	-2.5		2.5	
		V+ = 22V, V- = -11V,	+25°C	-0.5	0.03	0.5	nA
COMF Off-Leakage Current	ICOMF(OFF)	$V_{COMF} = \pm 10V, V_{NOF} = \mp 10V$	С, Е	-2.5		2.5	
		V+ = 22V, V- = -11V,	+25°C	-0.5	0.06	0.5	nA
COMF On-Leakage Current	ICOMF(ON)	$V_{COMF} = \pm 10V$	С, Е	-10		10	
Charge Injection	Q	V <sub>COMF</sub> = 0, Figure 13	C, E		80		рС
<b>60</b> $\Omega$ ANALOG SWITCH (SEI	NSE-GUARD)		<b>I</b> I				
Analog Signal Range	Vcoms, Vcomg, Vnos_, Vnog_	(Note 3)	C, E	V-		V+	V
On-Resistance	Don	V/2014 101/ 10014 1mA	+25°C		34	60	Ω
UII-RESISIONCE	Ron	$V_{COM} = 10V, I_{COM} = 1mA$	С, Е			70	
On-Resistance Match	ΔRon	V/2014 101/ 10014 1mA	+25°C		5	8	0
(Note 4)	ARON	$V_{COM} = 10V, I_{COM} = 1mA$	C, E			10	Ω

### ELECTRICAL CHARACTERISTICS—MAX4554 (+20V, -10V Supplies) (continued)

(V+ = +20V, V- = -10V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
On-Resistance Flatness (Note 5)	Rflat(on)	V <sub>COM</sub> = +5V, 0V, -5V; I <sub>COM</sub> = 10mA	+25°C C, E		3.5	9 10	Ω
NOS_, NOG_ Off-Leakage	INOS (OFF),	$V_{+} = 22V; V_{-} = -11V; V_{COM} = \pm 10V;$	+25°C	-0.25	0.02	0.25	
Current	INOS_(OFF), INOG_(OFF)	$V_{+} = 22V, V_{-} = -11V, V_{COM} = \pm 10V,$ $V_{NOS}, V_{NOG} = \pm 10V$	C, E	-2.5	0.02	2.5	nA
COMS, COMG Off-Leakage	ICOMS(OFF),	$V_{+} = 22V; V_{-} = -11V; V_{COM} = \pm 10V;$	+25°C	-0.25	0.02	0.25	
Current	ICOMS(OFF)	$V_{NOS_{-}}, V_{NOG_{-}} = \pm 10V$	C, E	-2.5		2.5	nA
COMS, COMG On-Leakage	ICOMS(ON),		+25°C	-0.5	0.04	0.5	
Current	ICOMG(ON)	$V_{+} = 22V, V_{-} = -11V, V_{COM} = \pm 10V$	С, Е	-5.0		5.0	nA
Charge Injection	Q	V <sub>COM</sub> = 0, Figure 13	+25°C		6		рС
LOGIC INPUT		•					
IN_, EN Input Logic Threshold High	V <sub>IN_H</sub> , V <del>EN</del> H		C, E		1.6	2.4	V
IN_, EN Input Logic Threshold Low	V <sub>IN_L</sub> , V <u>EN</u> L		C, E	0.8	1.6		V
IN_, EN Input Current Logic High or Low	I <sub>IN_H</sub> , I <sub>IN_L</sub> , I <u>EN</u> H, I <u>EN</u> L	$V_{IN} = V\overline{EN} = 0 \text{ or } VL$	C, E	-0.5	0.03	0.5	μA
SWITCH DYNAMIC CHARA	CTERISTICS						
Turn-On Time (Force)	ton	$V_{COMF} = 3V, R_L = 300\Omega,$	+25°C		150	300	ns
		Figure 10	C, E			350	
Turn-On Time	ton	V <sub>COMS</sub> , V <sub>COMG</sub> = 10V; R <sub>L</sub> = 1k $\Omega$ ;	+25°C		150	300 ns	ns
(Sense-Guard)		Figure 10	C, E		120	350	
Turn-Off Time (Force)	toff	$V_{COMF} = 3V, R_{L} = 300\Omega,$ Figure 10	+25°C C, E		130	300 350	ns
Turn-Off Time		V <sub>COMS</sub> , V <sub>COMG</sub> = 10V; R <sub>L</sub> = 1k $\Omega$ ;	+25°C		130	300	
(Sense-Guard)	toff	Figure 10	C, E		100	350	ns
· · ·			+25°C		375	500	
Enable Time On	ten	V <sub>COM</sub> = 10V, Figure 11	C, E			600	ns
Enchle Time Off	+	Version 10V/ Figure 11	+25°C		170	275	
Enable Time Off	ten	V <sub>COM</sub> = 10V, Figure 11	C, E			350	ns
NOF_ Off-Capacitance	Coff	V <sub>NOF</sub> = GND, f = 1MHz, Figure 14	+25°C		22		pF
NOS_, NOG_ Off-Capacitance	Coff	VNOS_, VNOG_ = GND; f = 1MHz; Figure 14	+25°C		7		pF
COMF Off-Capacitance	Coff	V <sub>COMF</sub> = GND, f = 1MHz, Figure 14	+25°C		50		pF
COMS, COMG Off-Capacitance	COFF	V <sub>COMS</sub> , V <sub>COMG</sub> = GND; f = 1MHz; Figure 14	+25°C		15		pF
COMF On-Capacitance	Con	V <sub>COMF</sub> = GND, f = 1MHz, Figure 14	+25°C		130		pF
COMS, COMG On-Capacitance	Con	V <sub>COMS</sub> , V <sub>COMG</sub> = GND; f = 1MHz; Figure 14	+25°C		30		pF
Total Harmonic Distortion (Force)	THD		+25°C		0.007		%
Off Isolation (Force)	Viso	$R_{IN}$ = 50 $\Omega$ , $R_{OUT}$ = 50 $\Omega$ , f = 1MHz, V <sub>COM</sub> = 100mV <sub>RMS</sub> , Figure 15	+25°C		-30		dB



# ELECTRICAL CHARACTERISTICS—MAX4554 (+20V, -10V Supplies) (continued)

(V+ = +20V, V- = -10V, VL = 5V, GND = 0V, VIN\_H = 2.4V, VIN\_L = 0.8V, TA = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
POWER SUPPLY							
Power-Supply Range	V+, VL, V-	VL ≥ 4.5V	C, E	±4.5		±20	V
V+ Supply Current	I+	V+ = 22V; V- = -11V;	+25°C	-1.0		1.0	μA
	1+	$V\overline{EN}$ , $V_{IN} = 0$ or VL	C, E	-5.0		5.0	μΑ
V- Supply Current	-	V+ = 22V; V- = -11V;	+25°C	-1.0		1.0	μA
	1-	$V\overline{EN}$ , $V_{IN} = 0$ or VL	C, E	-5.0		5.0	μΑ
VI Supply Current	IL+	V+ = 22V; V- = -11V;	+25°C	-1.0		1.0	μA
VL Supply Current	IL+	$V\overline{EN}$ , $VIN_{} = 0$ or $VL$	C, E	-5.0		5.0	μΑ
Ground Current	I <sub>GND</sub>	V+ = 22V; V- = -11V;	+25°C	-1.0		1.0	μA
	IGND	$V \overline{EN}$ , $V IN_{-} = 0$ or VL	C, E	-5.0		5.0	μΛ

# ELECTRICAL CHARACTERISTICS—MAX4554 (±15V Supplies)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, VIN\_H = 2.4V, VIN\_L = 0.8V, TA = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
$6\Omega$ ANALOG SWITCH (FOR	CE)						
Analog Signal Range	Vcomf, Vnof_	(Note 3)	C, E	V-		V+	V
On-Resistance	Ron	$V_{COMF} = \pm 10V, I_{COMF} = 10mA$	+25°C		4	6	Ω
OII-RESISIGNCE	KON	$VCOMF = \pm 10V$ , $ICOMF = 1011A$	С, Е			7	
On-Resistance Match	ΔRon	$V_{COME} = \pm 10V$ , $I_{COME} = 10mA$	+25°C		0.5	<u>1</u> 1.5 Ω	0
(Note 4)	AKON	$VCOMF = \pm 10V$ , $ICOMF = 10IIIA$	С, Е				
On-Resistance Flatness		$V_{COMF} = +5V, 0V, -5V;$	+25°C		0.1	<u>1</u> 1.5 Ω	
(Note 5)	Rflat(on)	$I_{COMF} = 10 \text{mA}$	C, E				
NOF_ Off-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.25	0.03	0.25	nA
	INOF_(OFF)	$V_{COMF} = \pm 10V, V_{NOF} = \mp 10V$	С, Е	-2.5		2.5	
		V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.03	0.5	nA
COMF Off-Leakage Current	ICOMF(OFF)	$V_{COMF} = \pm 10V, V_{NOF} = \mp 10V$	С, Е	-5.0		5.0	
COMF On-Leakage Current	100115/010	V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.06	0.5	
CONF ON-Leakage Current	ICOMF(ON)	$V_{COMF} = \pm 10V$	С, Е	-10		10	nA
Charge Injection	Q	V <sub>COMF</sub> = 0, Figure 13	+25°C		100		рС
60Ω ANALOG SWITCH (SEI	NSE-GUARD)	,					
Analog Signal Range	Vcoms, Vcomg, Vnos_, Vnog_	(Note 3)	C, E	V-		V+	V
On-Resistance	PoN	$V_{COM} = 10V_{COM} = 100$	+25°C		38	60	
CHERCESISIONCE	RON $V_{COM} = \pm 10V, I_{COM} = 1mA$	С, Е			70	Ω	

### ELECTRICAL CHARACTERISTICS—MAX4554 (±15V Supplies) (continued)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
On-Resistance Match	ΔRon	$V_{COM} = \pm 10V, I_{COM} = 1mA$	+25°C		5	9	Ω
(Note 4)	ARON	VCOM ±100,1COM 111A	С, Е			10	52
On-Resistance Flatness	Rflat(on)	V <sub>COM</sub> = +5V, 0V, -5V; I <sub>COM</sub> = 1mA	+25°C		1.5	5	Ω
(Note 5)	RFLAT(ON)	VCOM_ = +3V, 0V, -3V, ICOM_ = IIIA	C, E			6	52
NOS_, NOG Off-Leakage	INOS_(OFF),	V+ = 16.5V; V- = -16.5V;	+25°C	-0.25	0.01	0.25	nA
Current	INOG_(OFF)	$V_{COM} = \pm 10V$ ; $V_{NOS}$ , $V_{NOG} = \mp 10V$	C, E	-2.5		2.5	
COMS, COMG Off-Leakage	ICOMS(OFF),	V + = 16.5V; V - = -16.5V;	+25°C	-0.25	0.01	0.25	nA
Current	ICOMG(OFF)	$V_{COM} = \pm 10V; V_{NOS}, V_{NOG} = \mp 10V$	C, E	-2.5		2.5	
COMS, COMG On-Leakage	ICOMS(ON),	V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.02	0.5	nA
Current	ICOMG(ON)	$V_{COM} = \pm 10V$	C, E	-5.0		5.0	
Charge Injection	Q	V <sub>COM</sub> = 0, Figure 13	+25°C		4		рС
LOGIC INPUT							
IN_, EN Input Logic Threshold High	Vin_h, V <del>en</del> h		C, E		1.6	2.4	V
IN_, EN Input Logic Threshold Low	Vin_l, Venl		C, E	0.8	1.6		V
IN_, EN Input Current Logic High or Low	I <sub>IN_H</sub> , I <sub>IN_L</sub> , I <u>EN</u> H, I <u>EN</u> L	VEN = 0 or VL	C, E	-0.5	0.03	0.5	μA
SWITCH DYNAMIC CHARA	CTERISTICS						
Turn-On Time (Force)	ton	$V_{COM_{-}} = \pm 10V, R_{L} = 300\Omega,$	+25°C		135	275	DC
rum-on nine (roice)	ton	Figure 10	C, E			325	ns
Turn-On Time	tau	$V_{COM} = \pm 10V, R_{L} = 1k\Omega,$	+25°C		135	225	
(Sense-Guard)	ton	Figure 10	C, E			275	ns
		$V_{COM_{-}} = \pm 10V, R_{L} = 300\Omega,$	+25°C		170	275	
Turn-Off Time (Force)	toff	Figure 10	C, E			325	ns
Turn-Off Time		$V_{COM} = \pm 10V, R_L = 1k\Omega,$	+25°C		135	225	
(Sense-Guard)	toff	Figure 10	C, E			275	ns
		$V_{COM} = \pm 10V, R_L = 300\Omega,$	+25°C		310	500	
Enable Time On	ten	Figure 11	C, E			600	ns
		$V_{COM} = \pm 10V, R_L = 300\Omega,$	+25°C		170	300	
Enable Time Off	ten	Figure 11	C, E			400	ns
NOF_ Off-Capacitance	COFF	V <sub>NOF</sub> = GND, f = 1MHz, Figure 14	+25°C		22		pF
NOS_, NOG_ Off-Capacitance	COFF	V <sub>NOS_</sub> , V <sub>NOG_</sub> = GND; f = 1MHz; Figure 14	+25°C		9		pF
COMF Off-Capacitance	COFF	V <sub>COMF</sub> = GND, f = 1MHz, Figure 14	+25°C		29		pF
COMS, COMG Off-Capacitance	COFF	V <sub>COMS_</sub> , V <sub>COMG</sub> _= GND; f = 1MHz; Figure 14	+25°C		9		pF



# ELECTRICAL CHARACTERISTICS—MAX4554 (±15V Supplies) (continued)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, VIN\_H = 2.4V, VIN\_L = 0.8V, TA = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
COMF On-Capacitance	CON	V <sub>COMF</sub> = GND, f = 1MHz, Figure 14	+25°C		107		pF
COMS, COMG On-Capacitance	CON	VCOMS, VCOMG_ = GND; f = 1MHz; Figure 14	+25°C		29		pF
Total Harmonic Distortion (Force)	THD		+25°C		0.007		%
Off Isolation (Force)	V <sub>ISO</sub>	$R_{IN}$ = 50 $\Omega$ , $R_{OUT}$ = 50 $\Omega$ , f = 1MHz, V <sub>COM</sub> = 100mV <sub>RMS</sub> , Figure 15	+25°C		-30		dB
POWER SUPPLY							
Power-Supply Range	V+, VL, V-	$VL \ge 4.5V$	С, Е	±4.5		±20	V
	+	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0	
V+ Supply Current	1+	$V\overline{EN}$ , $VIN_{} = 0$ or V+	С, Е	-5.0		5.0	μΑ
V- Supply Current	1	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0	
	-	$V\overline{EN}$ , $VIN_{} = 0$ or V+	С, Е	-5.0		5.0	μΑ
M. Supply Current	L.	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0	
VL Supply Current	IL+	$V\overline{EN}$ , $V_{IN} = 0$ or V+	С, Е	-5.0		5.0	μΑ
Ground Current		V+ = 16.5V; V- = -16.5V;	+25°C	-1.0		1.0	
	Ignd	$V\overline{EN}$ , $VIN_{} = 0$ or V+	С, Е	-5.0		5.0	μA

# ELECTRICAL CHARACTERISTICS—MAX4555 (±15V Supplies)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
$6\Omega$ ANALOG SWITCH (FOR	CE)						
Analog Signal Range	VCOM_, VNO_	(Note 3)	С, Е	V-		V+	V
On-Resistance	Dev	$V_{COM} = +10V_{COM} = 10mA$	+25°C		3.8	6	Ω
UII-RESISIONCE	RON	$VCOM_ = \pm 10V, 1COM_ = 1011A$	С, Е			7	52
On-Resistance Match	ΔRon	Vacua 10V Jacua 10mA	+25°C		0.3	1	Ω
(Note 4)	ARON		С, Е			1.5	52
On-Resistance Flatness		$V_{COM} = +5V, 0V, -5V;$	+25°C		0.05	1	Ω
(Note 5)	Rflat(on)	$I_{COM}$ = 10mA	С, Е			1.5	32
NC_ Off-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.25	0.03	0.25	- nA
NC_OII-Leakage Current	INC_(OFF)	$V_{COM} = \pm 10V$ , $V_{NO} = \mp 10V$	С, Е	-2.5		2.5	
COM_ Off-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.03	0.5	n۸
COM_OII-Leakage Current	ICOM_(OFF)	$V_{COM} = \pm 10V, V_{NO} = \mp 10V$	С, Е	-5.0		5.0	- nA
COM On Lookago Current		$M_{(ON)} V_{+} = 16.5V, V_{-} = -16.5V, V_{COM_{-}} = \pm 10V$	+25°C	-0.5	0.06	0.5	nA
COM_ On-Leakage Current	ICOM_(ON)		С, Е	-10		10	
Charge Injection	Q	V <sub>COM</sub> = 0, Figure 13	+25°C	_	100		рС

M/X/W

### ELECTRICAL CHARACTERISTICS—MAX4555 (±15V Supplies) (continued)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
30 $\Omega$ ANALOG SWITCH (SE	NSE-GUARD)		I				
Analog Signal Range	VCOM_, VNO_	(Note 3)	С, Е	V-		V+	V
On Decistance	Den	Vacua 10V Jacua 10mA	+25°C		15	30	0
On-Resistance	Ron	$V_{COM} = \pm 10V$ , $I_{COM} = 10mA$	С, Е			45	Ω
On-Resistance Match	ΔRon	V <sub>COM</sub> = ±10V, I <sub>COM</sub> = 10mA	+25°C		0.6	4	Ω
(Note 4)	ARON	$VCOM_ = \pm 100$ , $ICOM_ = 1011A$	C, E			5	52
On-Resistance Flatness	RFLAT(ON)	$V_{COM} = +5V, 0V, -5V;$	+25°C		0.6	5	Ω
(Note 5)	RFLAT(ON)	$I_{COM} = 10 \text{mA}$	C, E			6	52
NC_ Off-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.3	0.01	0.3	nA
NC_OII-Leakage Cuitein	INC_(OFF)	$V_{COM} = \pm 10V, V_{NO} = \mp 10V$	C, E	-2.5		2.5	
COM_ Off-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.3	0.01	0.3	nA
COM_OII-Leakage Current	ICOM_(OFF)	$V_{COM} = \pm 10V$ , $V_{NO} = \mp 10V$	С, Е	-2.5		2.5	
COM_ On-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.6	0.02	0.6	nA
COM_ON-Leakage Current	I <sub>NC_(ON)</sub>	$V_{NC} = \pm 10V$	С, Е	-5.0		5.0	
Charge Injection	Q	V <sub>COM</sub> = 0, Figure 13	+25°C		4		рC
LOGIC INPUT							1
IN_ Input Logic Threshold High	V <sub>IN_H</sub>		C, E		1.6	2.4	V
IN_ Input Logic Threshold Low	V <sub>IN_L</sub>		C, E	0.8	1.6		V
IN_ Input Current Logic High or Low	I <sub>IN_H</sub> , I <sub>IN_L</sub>	V <sub>IN</sub> _ = 0.8V or 2.4V	C, E	-0.5	0.03	0.5	μA
SWITCH DYNAMIC CHARA	CTERISTICS		•				
Turn On Time (Force)		$V_{COM} = \pm 3V$ , $R_L = 300\Omega$ ,	+25°C		155	275	<b>D</b> C
Turn-On Time (Force)	ton	Figure 10	C, E			325	ns
Turn-On Time		$V_{COM} = \pm 10V, R_{L} = 1k\Omega,$	+25°C		125	225	
(Sense-Guard)	ton	Figure 10	C, E			275	ns
		$V_{COM} = \pm 3V$ , $R_L = 300\Omega$ ,	+25°C		190	275	
Turn-Off Time (Force)	toff	Figure 10	C, E			325	ns
Turn-Off Time		$V_{COM} = \pm 10V, R_{L} = 1k\Omega,$	+25°C		125	225	
(Sense-Guard)	toff	Figure 10	С, Е			275	ns
COM_ Off-Capacitance (Force)	Coff	V <sub>COM_</sub> , V <sub>NO</sub> = GND; f = 1MHz; Figure 14	+25°C		29		pF
COM_ On-Capacitance (Sense-Guard)	CON	V <sub>COM_</sub> , V <sub>NO</sub> _ = GND; f = 1MHz; Figure 14	+25°C		9		pF
COM_ On-Capacitance (Force)	CON	V <sub>COM_</sub> , V <sub>NO</sub> _ = GND; f = 1MHz; Figure 14	+25°C		107		pF
COM_ Off-Capacitance (Sense-Guard)	COFF	V <sub>COM_</sub> , V <sub>NO</sub> _ = GND; f = 1MHz; Figure 14	+25°C		29		pF

# ELECTRICAL CHARACTERISTICS—MAX4555 (±15V Supplies) (continued)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, VIN\_H = 2.4V, VIN\_L = 0.8V, TA = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS	
NC_ Off-Capacitance (Force)	COFF	V <sub>COM_</sub> , V <sub>NO_</sub> = GND; f = 1MHz; Figure 14	+25°C		22		pF	
NC_ Off-Capacitance (Sense-Guard)	COFF	V <sub>COM_</sub> , V <sub>NO_</sub> = GND; f = 1MHz; Figure 14	+25°C		9		pF	
Total Harmonic Distortion (Force)	THD		+25°C		0.007		%	
Off Isolation (Force) (Note 6)	VISO	$ \begin{array}{l} R_{\text{IN}} = 50\Omega,  R_{\text{OUT}} = 50\Omega,  f = 1 \text{MHz}, \\ V_{\text{COM}\_} = 100 \text{mV}_{\text{RMS}},  Figure  15 \end{array} $	+25°C		-38		dB	
POWER SUPPLY	•							
Power-Supply Range	V+, VL, V-		С, Е	±4.5		±20	V	
	+	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0		
V+ Supply Current	1+	$V\overline{EN}$ , $VIN_{} = 0$ or V+	С, Е	-5.0		5.0	μA	
V- Supply Current	-	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0		
v- Supply Current	1-	$V\overline{EN}$ , $VIN_{} = 0$ or V+	С, Е	-5.0		5.0	μA	
VI Supply Current	L.	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0		
VL Supply Current	IL+	$V\overline{EN}$ , $V_{IN} = 0$ or V+	С, Е	-5.0		5.0	μA	
Ground Current	IGND	V+ = 16.5V; V- = -16.5V;	+25°C	-1.0	0.001	1.0		
	IGND	$V\overline{EN}$ , $VIN_{=} 0$ or $V+$	С, Е	-5.0		5.0	μA	

# ELECTRICAL CHARACTERISTICS—MAX4556 (±15V Supplies)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	МАХ	UNITS
<b>6</b> $\Omega$ ANALOG SWITCH (FOR	CE)						
Analog Signal Range	V <sub>COM1</sub> , V <sub>NO1</sub> , V <sub>NC1</sub>	(Note 3)	C, E	V-		V+	V
On-Resistance	Ron	$V_{COM1} = \pm 10V, I_{COM1} = 10mA$	+25°C		3.8	6	0
OII-RESISIONCE	KON	$VCOM^{-1} = \pm 10^{\circ}$ , $ICOM^{-1} = 1011A$	C, E			7	Ω
On-Resistance Match	ΔRon	VCOM1 = ±10V, ICOM1 = 10mA	+25°C		0.3	1	1 Ω
(Note 4)	ARON	$VCOMT = \pm 10V, ICOMT = 1011A$	C, E			1.5	
On-Resistance Flatness		$V_{COM1} = +5V, 0V, -5V;$	+25°C		0.05	1	Ω
(Note 5)	Rflat(on)	$I_{COM1} = 10 \text{mA}$	C, E			1.5	] 22
NO1, NC1 Off-Leakage	INO1(OFF),	V+ = 16.5V; V- = -16.5V;	+25°C	-0.25	0.03	0.25	nA
Current	NC1(OFF)	$V_{COM1} = \pm 10V$ ; $V_{NO1}$ , $V_{NC1} = \mp 10V$	C, E	-2.5		2.5	
COM1 Off-Leakage Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.03	0.5	nA
CONT OII-Leakage Current	ICOM1(OFF)	$V_{COM1} = \pm 10V$ , $V_{NO1} = \mp 10V$	C, E	-5.0		5.0	
COM1 On Loakago Current		V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.06	0.5	nA
COM1 On-Leakage Current	ICOM1(ON)	$V_{COM1} = \pm 10V$	C, E	-10		10	1 114
Charge Injection	Q	$V_{COM1} = 0$ , Figure 13	+25°C		100		рС

# ELECTRICAL CHARACTERISTICS—MAX4556 (±15V Supplies) (continued)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP (Note 2)	MAX	UNITS
60 $\Omega$ ANALOG SWITCH (SE	NSE-GUARD)						1
Analog Signal Range	V <sub>COM_</sub> , V <sub>NO_</sub> , V <sub>NC_</sub>	(Note 3)	C, E	V-		V+	V
On-Resistance	Ron	V <sub>COM</sub> = ±10V, I <sub>COM</sub> = 10mA	+25°C		36	60	Ω
			C, E			70	
On-Resistance Match (Note 4)	$\Delta R_{ON}$	$V_{COM}$ = ±10V, $I_{COM}$ = 10mA	+25°C C, E		5	9 10	Ω
On-Resistance Flatness (Note 5)	Rflat(on)	V <sub>COM</sub> = +5V, 0V, -5V; I <sub>COM</sub> = 10mA	+25°C C, E		0.6	5 6	Ω
			+25°C	0.25	0.01	-	
NO_, NC Off-Leakage Current	INO_(OFF), INC_(OFF)	V+ = 16.5V; V- = -16.5V; V <sub>COM</sub> _ = ±10V; V <sub>NO</sub> _, V <sub>NC</sub> _ = ∓ 10V	+25°C	-0.25 -2.5	0.01	0.25 2.5	nA
		V+ = 16.5V; V- = -16.5V;	+25°C	-0.25	0.01	0.25	- nA
COM_ Off-Leakage Current	ICOM_(OFF)	$V_{COM} = \pm 10V; V_{NO}, V_{NC} = \mp 10V$	C, E	-2.5		2.5	
		V+ = 16.5V, V- = -16.5V,	+25°C	-0.5	0.02	0.5	nA
COM_ On-Leakage Current	ICOM_(ON)	$V_{COM} = \pm 10V$	C, E	-5.0		5.0	
Charge Injection	Q	V <sub>COM</sub> = 0, Figure 13 +2			5		pC
IN_ Input Logic Threshold High	VIN_H		C, E		1.6	2.4	V
IN_ Input Logic Threshold Low	V <sub>IN_L</sub>		C, E	0.8	1.6		V
IN_ Input Current Logic High or Low	lin_h, lin_l	VIN_ = 0 or VL	C, E	-0.5	0.03	0.5	μA
SWITCH DYNAMIC CHARA	CTERISTICS						
Transition Time (Force)	ttrans	$V_{COM_{=}} \pm 10V, R_{L} = 300\Omega,$	+25°C		150	250	ns
		Figure 10	C, E			300	
Transition Time	<b>t</b> TRANS	$V_{COM} = \pm 10V, R_L = 1k\Omega,$	+25°C		125	225	- ns
(Sense-Guard)		Figure 10	C, E			275	
Break-Before-Make Time	tввм	$V_{COM} = \pm 10V$ , $R_L = 1k\Omega$ , Figure 12	+25°C	1	15		ns
NO1, NC1 Off-Capacitance (Force)	Coff	V <sub>NO1</sub> , V <sub>NC1</sub> = GND; f = 1MHz; Figure 14	+25°C		21		pF
COM1 On-Capacitance (Force)	Con	V <sub>COM1</sub> = GND, f = 1MHz, Figure 14	+25°C	137			pF
NO_, NC_ Off-Capacitance (Sense-Guard)	COFF	V <sub>NO_</sub> , V <sub>NC</sub> _ = GND; f = 1MHz; Figure 14	+25°C	7			pF
COM_ On-Capacitance (Sense-Guard)	Con	V <sub>COM</sub> = GND, f = 1MHz, Figure 14	+25°C	30			pF
Total Harmonic Distortion (Force)	THD		+25°C		0.007		%
Off Isolation (Force)	VISO	$\label{eq:RIN} \begin{array}{l} R_{\text{IN}} = 50 \Omega, \ R_{\text{OUT}} = 50 \Omega, \ f = 1 M Hz, \\ V_{\text{COM}} = 100 m V_{\text{RMS}}, \ Figure \ 15 \end{array}$	+25°C		-30		dB



# ELECTRICAL CHARACTERISTICS—MAX4556 (±15V Supplies) (continued)

(V+ = +15V, V- = -15V, VL = 5V, GND = 0V, V<sub>IN\_H</sub> = 2.4V, V<sub>IN\_L</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	ТА	MIN	TYP (Note 2)	МАХ	UNITS	
POWER SUPPLY								
Power-Supply Range	V+, VL, V-	$VL \ge 4.5V$	C, E	±4.5		±20	V	
V+ Supply Current	I+	V+ = 16.5V, V- = -16.5V,	+25°C	-1.0	0.001	1.0		
		$V_{IN} = 0 \text{ or } VL$	C, E	-5.0		5.0	μA	
V- Supply Current	-	$V_{+} = 16.5V, V_{-} = -16.5V, V_{IN_{-}} = 0 \text{ or } VL$	+25°C	-1.0	0.001	1.0	μΑ	
			C, E	-5.0		5.0		
M. Supply Current	IL+	V+ = 16.5V, V- = -16.5V,	+25°C	-1.0	0.001	1.0		
VL Supply Current		$V_{IN} = 0 \text{ or } VL$	C, E	-5.0		5.0	μA	
Ground Current	I <sub>GND</sub>	V+ = 16.5V, V- = -16.5V,	+25°C	-1.0	0.001	1.0	μA	
		$V_{IN} = 0 \text{ or } VL$	C, E	-5.0		5.0	μΑ	

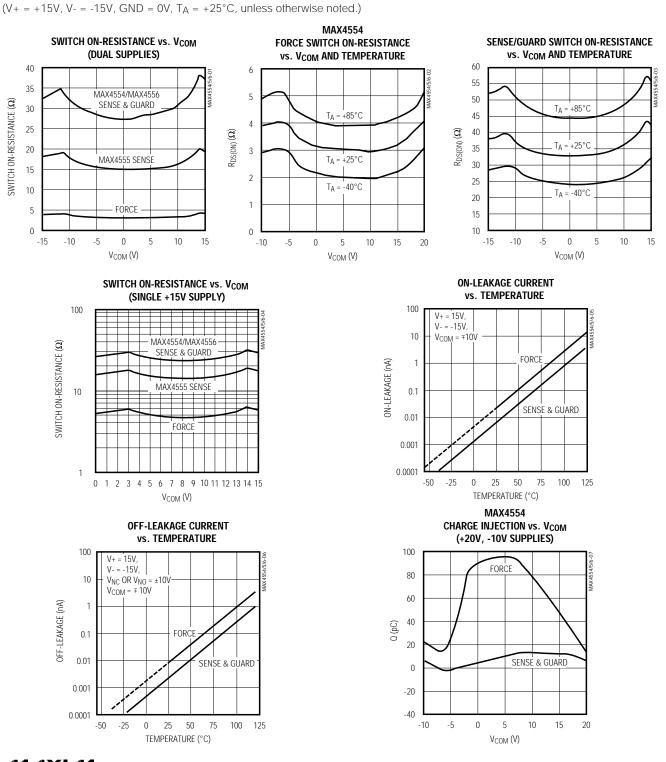
Note 2: The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

**Note 3:** Guaranteed by design.

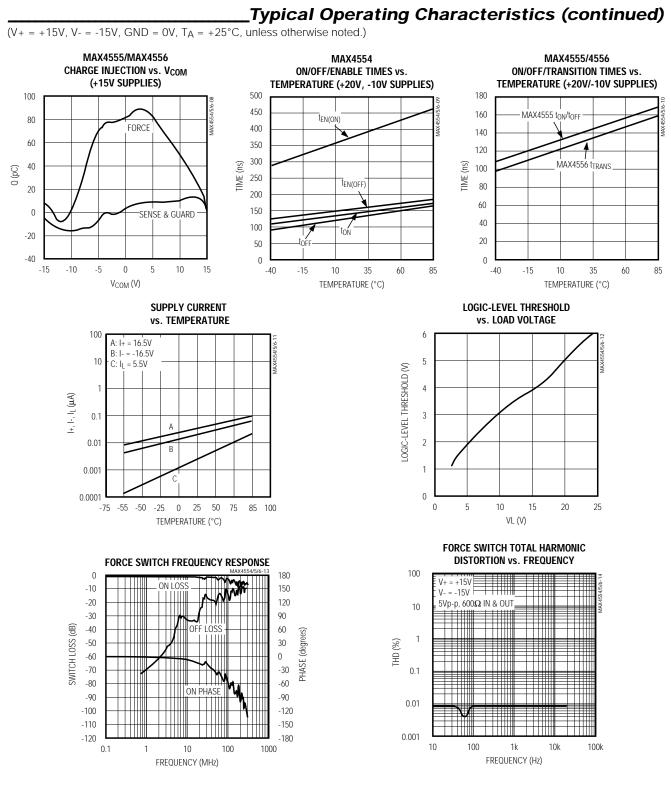
**Note 4:**  $\Delta R_{ON} = \Delta R_{ON}(MAX) - \Delta R_{ON}(MIN)$ .

**Note 5:** Resistance flatness is defined as the difference between the maximum and the minimum value of on-resistance as measured over the specified analog signal range.





M/IXI/M



///XI/M

MAX4554/MAX4555/MAX4556

# \_Pin Description

PIN			EUNICTION		
MAX4554	MAX4555	MAX4556	NAME	FUNCTION	
1	_	_	NOG1	Analog Guard Channel 1 Normally Open Terminal	
_	_	1, 2	NO3, NO2	Analog Signal Normally Open Terminals	
2	_	_	NOS1	Analog Sense Channel 1 Normally Open Terminal	
_	2, 15*, 10*, 7	14*, 15, 16	COM1, COM2 COM3, COM4	Analog Signal Common Terminals. COM2 and COM3 are low-resis- tance (force) switches on the MAX4555. COM1 is a low-resistance (force) switch on the MAX4556.	
3*	_	_	NOF1*	Analog Force Channel 1 Normally Open Terminal	
	3, 14, 11, 6		NC1, NC2, NC3, NC4	Analog Signal Normally Closed Pins. NC2 and NC3 are low-resistance (force) switches.	
_	—	3*	NO1*	Analog Force Signal Normally Open Terminal	
4	4	4	V-	Negative Analog Supply Voltage Input. Connect to GND for single- supply operation.	
5	5	5	GND	Ground. Connect to digital ground. (Analog signals have no ground reference; they are limited to V+ and V)	
6*	_	_	NOF2*	Analog Force Channel 2 Normally Open Terminal	
_	_	6*	NC1*	Analog Force Signal Normally Closed Terminal	
7	_	_	NOS2	Analog Sense Channel 2 Normally Open Terminal	
_	_	7,8	NC2, NC3	Analog Signal Normally Closed Terminal	
8	_	_	NOG2	Analog Guard Channel 2 Normally Open Terminal	
9	_	_	ĒN	Enable Logic-Level Digital Input. Connect to GND to enable all switches	
11, 10	1, 16, 9, 8	9, 10, 11	IN1, IN2, IN3, IN4	Logic-Level Digital Inputs. See Truth Tables.	
12	12	12	VL	Logic-Level Positive Supply Input. Connect to logic (+5V) supply. Can be connected to V+ for single-supply operation.	
13	13	13	V+	Positive Analog Supply Voltage Input. Internally connected to sub- strate.	
14*	—	_	COMF*	Analog Force Channel Common Terminal	
15	_	_	COMS	Analog Sense Channel Common Terminal	
16	_		COMG	Analog Guard Channel Common Terminal	

\* Indicates high-current, low-resistance (force) switch terminal.

**Note:** NO\_, NC\_, and COM\_ pins are identical and interchangeable. Any may be considered as an input or output; signals pass equally well in either direction.

# Force-Sense Philosophy

When a precise voltage must be applied to a load that draws appreciable current, the resistance of the conductors connecting the source and the load can degrade the load voltage. The resistance of the conductors forms a voltage divider with the load, so that the load voltage is lower than the source voltage. The greater the distance between the source and the load, and the greater the current or conductor resistance, the greater the degradation. The resulting signal reduction can be overcome and the signal at the load guaranteed by using a 4-wire technique known as Kelvin sensing, or force-sense.

The basic idea behind the force-sense philosophy is to use four wires, forcing a voltage or current through two high-current wires to the load, and measuring (sensing) the voltage with two separate wires that carry very low or negligible current. One of two basic configurations is used, depending on whether or not feedback is employed:

- The sensed voltage can be completely independent of the forced voltage or current, as in the case of a 4-wire ohmmeter, where a constant current is forced through one pair of wires and the voltage at the resistor is measured by another pair.
- 2) The sensed voltage can be part of a feedback circuit to force the load voltage to the desired value, as in the case of a 4-wire power supply. (In rare cases, this method is also used to measure resistance; the source is forced to produce a desired voltage in the resistor, and the source current required to achieve this voltage is measured.)

In all cases, the resistance of the high-current conductors can be ignored and the sensed voltage is an accurate measure of the load (or resistor's) voltage, despite appreciable voltage loss in the wires connecting the source and load.

There are two limitations to this scheme. First, the maximum source voltage (compliance) must be able to overcome the combined voltage loss of the load and the connecting wires. In other words, the conductors in the force circuit can have significant resistance, but there is a limit. Second, the impedance of the sensing circuit (typically a voltmeter, A/D converter, or feedback amplifier) must be very high compared to the load resistance and the sense wire resistance. These limitations are usually simple to overcome. The source compliance is usually required to be only a volt more than the load voltage, and the sense circuit usually has a multimegohm impedance. Typical 4-wire force-sense configurations are shown in Figure 1.

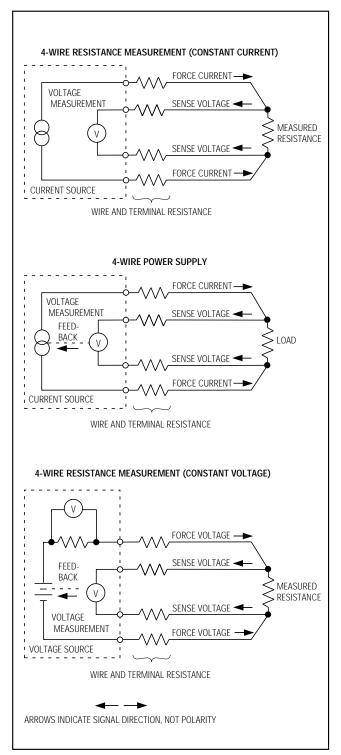


Figure 1. 4-Wire Force-Sense Measurements

MIXIM

# Guard Philosophy

When measuring a precise voltage from a high-resistance source, or when measuring a very small current or forcing it into a load, unwanted leakage currents can degrade the results. These leakage currents may exist in the insulation of wires connecting the source and the measuring device. Higher source voltages, higher source impedances, longer wires, lower currents, and higher temperatures further degrade the measurement. The effect has both DC and low-frequency AC components; AC signals are generally capacitively coupled into the high-impedance source and wiring. The AC and DC effects are hard to separate, and are generally grouped under the designation "low-frequency noise." This signal degradation can be overcome and the measured signal guaranteed by using a 3-wire technique known as guarding.

A "guard," "guard channel," or "driven guard" is formed by adding a third wire to a 2-wire measurement. It consists of a physical barrier (generally the surrounding shield of a coaxial cable) that is actively forced to the same voltage as is being measured on its inner conductor. The forcing of the driven guard is from the output of a low-impedance buffer amplifier whose high-impedance input is connected to the source. The idea is not just to buffer or shield the signal with a low-impedance source but, by forcing the shield to the same potential as the signal, to also force the leakage currents between the signal and the outside world to extremely small values. Any unwanted leakage current from the source must first go through the coaxial-cable insulation to the shield. Since the shield is at the same potential, there is virtually no unwanted leakage current, regardless of the insulation resistance. The shield itself can have significant leakage currents to the outside world, but it is separated from the measured signal.

The physical positioning of the guard around the signal is extremely important in maintaining low leakage. Since the guard can be at potentials far from ground, conventional coaxial cable is often replaced by triaxial cable (i.e., cable with a center conductor and two separate inner and outer shields). The signal is the center conductor, the inner shield is the guard, and the outer shield is the chassis ground. The outer shield isolates the inner driven guard from ground, physically protects the driven guard, and acts as a secondary Faraday shield for external noise.

The physical guard must be maintained continuously from the source to the measuring device, including paths on printed circuit boards, where the guard becomes extra traces surrounding the signal traces on both sides (and above and below the signal traces on

# **Force-Sense Switches**

multilevel boards.) This is one case where a ground plane is *not* appropriate. In extreme cases, such as with nano-voltmeters and femto-ammeters, printed circuit boards cannot be adequately shielded and are eliminated from the guarded signal paths altogether.

Figure 2 shows both the basic 3-wire guarded measurement and a 5-wire variation, used for balanced signals that are elevated from ground potential. The 5-wire configuration is really two 3-wire circuits sharing a common ground. Figure 2 also shows the configuration using triaxial cable.

### \_Force-Sense-Guard Philosophy

Force-sense measurements are combined with guarded measurements when a wide range of voltages and currents are encountered, or when voltage and current must be accurately measured or controlled simultaneously. This frequently occurs in automatic test equipment (ATE) and in some critical physical or chemical sensor applications where voltage and/or current measurements can span many decades. Two techniques are used: 8-wire and 12-wire.

### 8-Wire Measurements

Figure 3 shows an 8-wire guarded force-sense power supply. A precise voltage is forced to the load, and load current is sensed without interacting with the output voltage, and without unwanted leakage currents. Separate twin-axial, or "twinax" cable is used for each of the positive and negative wires. Each cable has a twisted-pair of wires surrounded by a common shield, which is connected as the driven guard. Since the force and sense wires are at approximately the same potential, they can be protected by the same driven guard. In critical applications, two special 4-wire cables and connectors are substituted for the two twinax cables and separate ground wire. These cables add a second shield, which replaces the chassis-to-chassis ground wire and reduces noise.

Figure 3 shows current sensing with a fixed precision resistor and voltmeter, but other methods (such as op amps with feedback) are frequently employed, particularly if current limiting is required. One of the advantages of Figure 3's circuit is that leakage in the current-sensing path has no effect on the output voltage.

The two diodes in the force-sense feedback path protect the force-sense amplifier from operating open loop if either the force or sense wires are disconnected from the load. These diodes must have both lower forward voltage and lower reverse leakage than the current being measured.







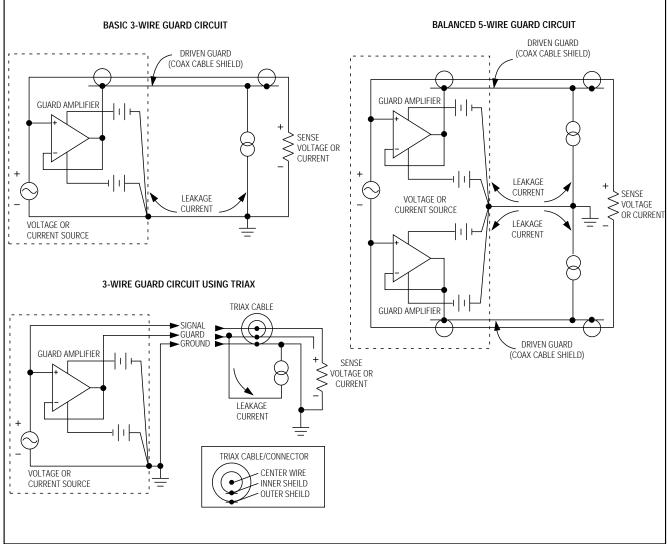


Figure 2. 3-Wire and 5-Wire Guarded Measurements

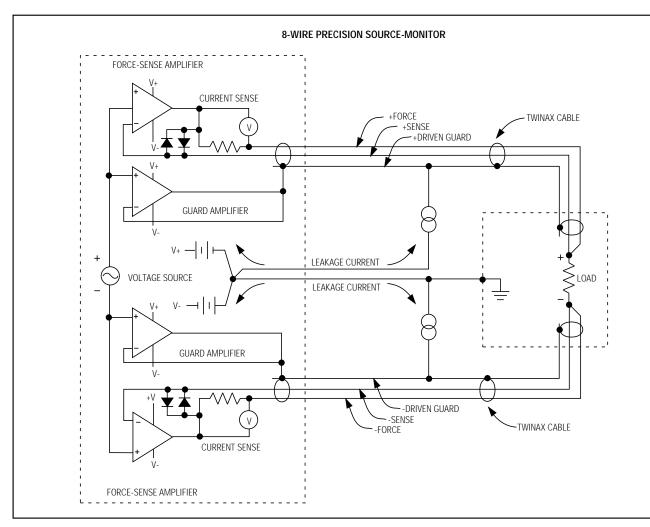


Figure 3. 8-Wire Guarded Force-Sense Measurements

Note that although the positive and negative circuits are identical, they are not redundant. Both are always used, even when one side of the load is grounded, because maintaining a precision output voltage requires losses in the ground leads to be corrected by a force-sense amplifier. If more than one power supply and load are operated together, and they have a common connection, this requirement becomes even more critical. Separate 8-wire connections prevent current changes in one load from changing voltage in the other load.

### **12-Wire Measurements**

Figure 4 shows a 12-wire circuit, which is an elaboration of the 8-wire system using separate driven guards for the force and sense wires. Four sets of triaxial cables and connectors are used. The extra wires are used for two reasons: 1) They provide better shielding by having separate chassis grounds on each cable, rather than separate ground wires external to the signal cables; 2) In test equipment, where connection changes are frequent, it is very convenient to use four triax connectors or two quadrax (dual triax) connectors for each load.

In addition, this method is slightly better for power supplies or measurements that switch between constant voltage and constant current, since separate driven guards reduce circuit capacitance. Also, when troubleshooting, it is convenient to be able to interchange force and sense leads.

M/IXI/M

17

MAX4554/MAX4555/MAX4556

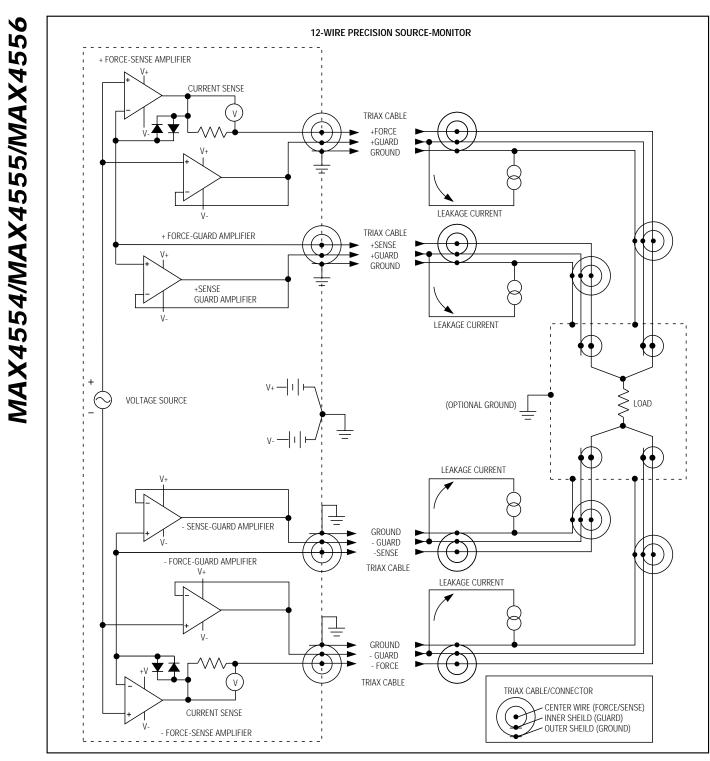


Figure 4. 12-Wire Guarded Force-Sense Measurements

M/X/W

### Switching Guarded and Force-Sense Signals

When a precision source or measurement must be connected sequentially to several circuits, all sense and guard connections must be switched simultaneously, and at least one of the force connections must be switched. To maintain safety and low noise levels, the ground (or chassis) connection should never be disconnected.

The force circuit switch should have low-resistance, high-current capability, but the sense and guard circuit switches require only moderate resistance and current capability. The sense and guard switches should have lower leakage than the lowest measured current. CMOS switches should also be operated from power supplies higher than the highest circuit voltage to be switched.

### \_Detailed Description

The MAX4554/MAX4555/MAX4556 are CMOS analog ICs configured as force-sense switches. Each part contains low-resistance switches for forcing current, and higher resistance switches for sensing a voltage or driving guard wires. Analog signals on the force, sense, or guard circuits can range from V- to V+. Each switch is completely symmetrical and signals are bidirectional; any switch terminal can be an input or output. The switches' open or closed states are controlled by TTL/CMOS-compatible input (IN\_) pins.

The MAX4555 and MAX4556 are characterized and guaranteed only with  $\pm$ 15V supplies, but they can operate from a single supply up to  $\pm$ 44V or non-symmetrical supplies with a voltage totaling less than  $\pm$ 44V. The MAX4554 is fully characterized for operation from  $\pm$ 15V supplies, and it is also fully specified for operation with  $\pm$ 20V and  $\pm$ 10V supplies. A separate logic supply pin, VL, allows operation with  $\pm$ 5V or  $\pm$ 3V logic, even with unusual V+ values. The negative supply pin, V-, must be connected to GND for single-supply operation.

The MAX4554 contains two force switches, two sense switches, and two guard switches configured as two 3PST switches. The two switches operate independently of one another, but they have a common connection, allowing one source to be connected simultaneously to two loads, or two sources to be connected to one load. An enable pin,  $\overline{\text{EN}}$ , turns all switches off when driven to logic high. The MAX4554 is also fully specified for operation with +20V and -10V supplies. The MAX4555 contains four independent SPDT, NC switches; two are force switches and two are sense switches. The MAX4556 contains three independent SPDT switches; one is a force switch and two are sense switches.

# **Force-Sense Switches**

### Switch Resistances

Each IC contains four internal switches: four low-current sense-guard switches and two high-current force switches. Each sense-guard switch has an on-resistance of approximately 60 $\Omega$ , while each force switch has an on-resistance of approximately 6 $\Omega$ . The MAX4555's two low-current sense-guard switches are connected in parallel to produce lower on-resistance and allow higher current.

### **Power-Supply Considerations**

### Overview

The MAX4554/MAX4555/MAX4556's construction is typical of most CMOS analog switches. They have four supply pins: V+, V-, VL, and GND. V+ and V- are used to drive the internal CMOS switches and set the analog voltage limits on any switch. Reverse ESD protection diodes are internally connected between each analog and digital signal pin and both V+ and V-. If any signal exceeds V+ or V-, one of these diodes will conduct. During normal operation these reverse-biased ESD diodes leak, forming the only current drawn from the signal paths.

Virtually all the analog leakage current comes through the ESD diodes to V+ or V-. Although the ESD diodes on a given signal pin are identical, and therefore fairly well balanced, they are reverse biased differently. Each is biased by either V+ or V- and the analog signal. This means their leakages vary as the signal varies. The *difference* in the two diode leakages from the signal path to the V+ and V- pins constitutes the analog-signal-path leakage current. All analog leakage current flows to the supply terminals, not to the other switch terminal. This explains how both sides of a given switch can show leakage currents of either the same or opposite polarity.

There is no connection between the analog signal paths and GND or VL. The analog signal paths consist of an N-channel and P-channel MOSFET with their sources and drains paralleled, and their gates driven out of phase to V+ and V- by the logic-level translators.

VL and GND power the internal logic and logic-level translator and set the input logic threshold. The logic-level translator converts the logic levels to switched V+ and V- signals for driving the gates of the analog switches. This drive signal is the only connection between GND and the analog supplies. V+ and V- have ESD-protection diodes to GND. The logic-level inputs (IN\_, and EN) have ESD protection to V+ and V-, but not to GND; therefore, the logic signal can go below GND (as low as V-) when bipolar supplies are used. The logic-level threshold V<sub>IN</sub> is CMOS and TTL compatible when VL is between 4.5V and 36V (see *Typical Operating Characteristics*).



Increasing V- has no effect on the logic-level thresholds, but it does increase the drive to the internal Pchannel switches, reducing the overall switch on-resistance. V- also sets the negative limit of the analog signal voltage.

### **Bipolar-Supply Operation**

The MAX4554/MAX4555/MAX4556 operate with bipolar supplies between ±4.5V and ±18V. However, since all factory characterization is done with ±15V supplies (and +20V, -10V for MAX4554), operation at other supplies is not guaranteed. The V+ and V- supplies need not be symmetrical, but their sum cannot exceed the absolute maximum rating of 44V (see *Absolute Maximum Ratings*). VL must not exceed V+.

### Single-Supply Operation

The MAX4554/MAX4555/MAX4556 operate from a single supply between +4.5V and +44V when V- is con-

nected to GND. All of the bipolar precautions must be observed.

### Applications Information

### Switching 4-Wire Force-Sense Circuits

Figure 5 shows how to switch a single voltage or current source between two loads using two MAX4555s. A single CMOS inverter ensures that only one switch is on at a time. On each MAX4555, switches 2 and 3 are the high-current switches, so they should be used for force circuits. By interchanging loads and sources, the circuit can be reversed to switch two sources to a single load. Additional MAX4555s and loads or sources can be added to expand the circuit, but additional IN\_ address decoding must be incorporated.

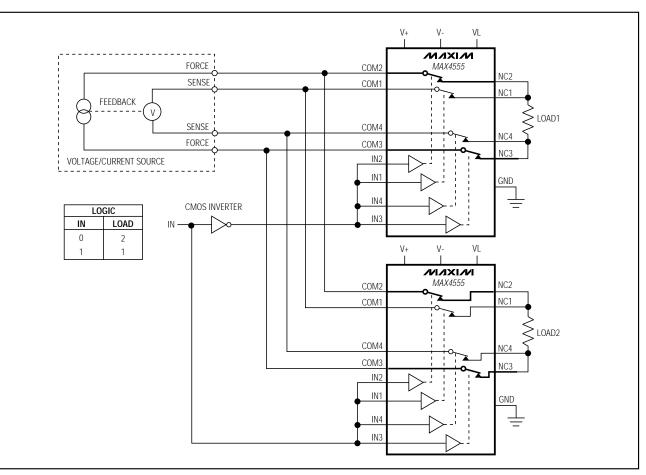


Figure 5. Using the MAX4555 to Switch 4-Wire Force-Sense Circuits from One Source to Two Loads

# MAX4554/MAX4555/MAX4556

# **Force-Sense Switches**

Figure 6 shows how to switch a single voltage or current source between two loads using the MAX4554 or MAX4556. By interchanging loads and sources, the circuits can be reversed so that they switch two sources to a single load. The two loads are electrically connected together at one point, but may be physically separated. This means that one force wire does not need to be switched, but the corresponding sense wires do.

The MAX4554 has independent 3PST, NO switches driven out of phase by an external CMOS inverter, so that one switch is on while the other is off. If both switches were turned on at the same time, both loads would be connected, and the resulting voltage at either load

would be close to (but not exactly equal to) the desired value; this would not cause any damage to the device.

### Switching 3-Wire Guarded Circuits

Figure 7 shows how to switch a single guarded voltage or current source between two loads using the MAX4554 or MAX4556. By interchanging loads and sources, the circuits can be reversed to switch two sources to a single load. If the loads have a common connection, the switch to that node can be eliminated.

Note that these circuits use sense (high-resistance) switches to switch the common wire. This is permissible only if the load currents are very low. If the currents are high, the common connection should not be switched unless another force switch is substituted.

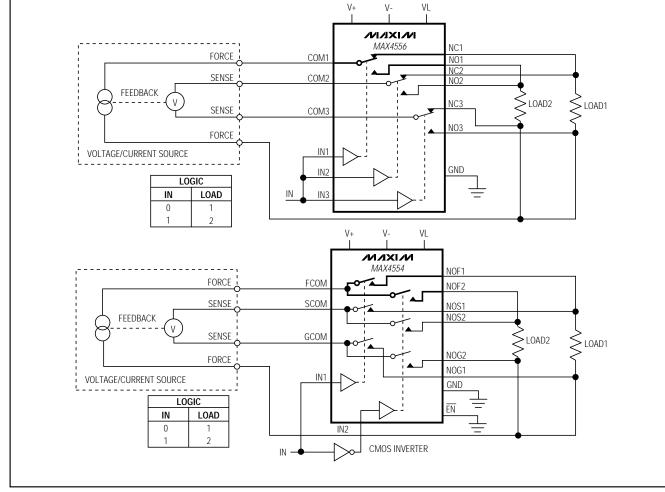


Figure 6. Using the MAX4554/MAX4556 to Switch 4-Wire Force-Sense Circuits from One Source to Two Loads



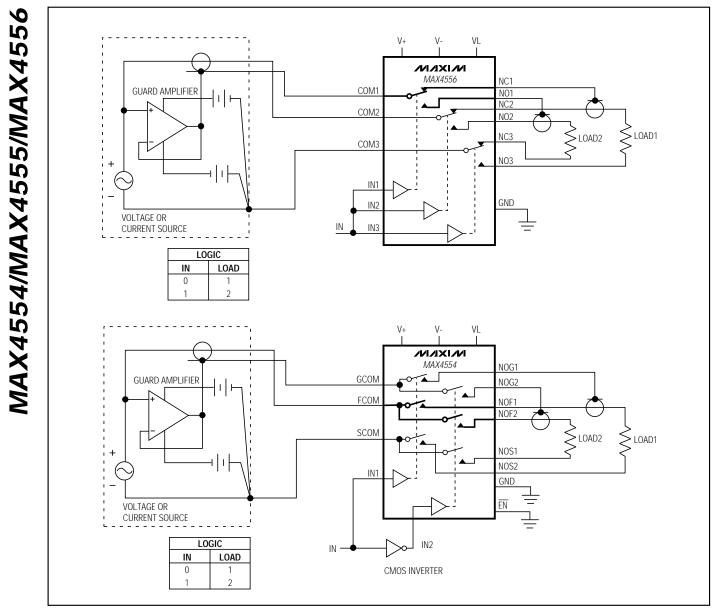


Figure 7. Using the MAX4554/MAX4556 to Switch 3-Wire Guarded Circuits from One Source to Two Loads

### High-Frequency Performance

Although switching speed is restricted, once a switch is in a steady state it exhibits good RF performance. In  $50\Omega$  systems, signal response is reasonably flat up to 50MHz (see Typical Operating Characteristics). The force switches have lower on-resistance, so their insertion loss in 50 $\Omega$  systems is lower. Above 20MHz, the on-response has several minor peaks that are highly layout dependent. The problem with high-frequency operation is not turning the switches on, but turning them off. The off-state switches act like capacitors and pass higher frequencies with less attenuation. At 10MHz, off-isolation between input or output signals is approximately -30dB in 50 $\Omega$  systems, degrading (approximately 20dB per decade) as frequency increases. Higher circuit impedances also degrade offisolation.

VI //IXI//I MAX4555 COM1 NC1 GUARD AMPLIFIER COM2 NC ≥LOAD2 COM3 NC3 COM4 NC4 IN1 IN2 GND LOAD1 IN3 VOLTAGE OR IN4 CURRENT SOURCE LOGIC IN LOAD 0 2 1 1

Figure 8. Using the MAX4555 to Switch 3-Wire Guarded Circuits from One Source to Two Loads

Figure 8 shows how to switch a single guarded voltage

or current source between two grounded loads using a

MAX4555. By interchanging loads and sources, the cir-

cuits can be reversed so that two sources are switched

Figure 9 shows how to switch a single 8-wire guarded

force-sense voltage or current source between two

loads using two MAX4556s or two MAX4554s. By inter-

changing loads and sources, the circuits can be

reversed so that they switch two sources to a single

load. The two loads are shown isolated from each

another, but if they have a common connection then the

circuit must remain as shown in order to maintain accu-

Switching 8-Wire Guarded Circuits

to a single load.

rate load voltage.

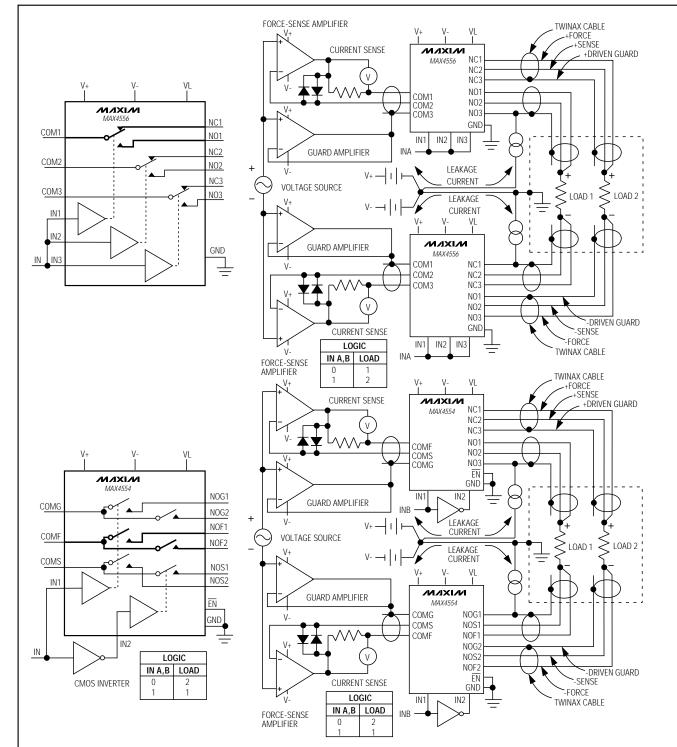


Figure 9. Switching 8-Wire Guarded Force-Sense Measurements from One Precision Source-Monitor to Two Loads

# Test Circuits/Timing Diagrams

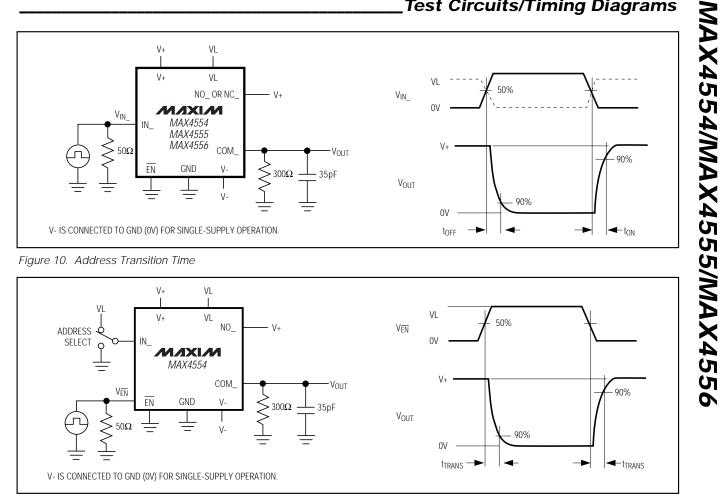


Figure 11. Enable Transition Time

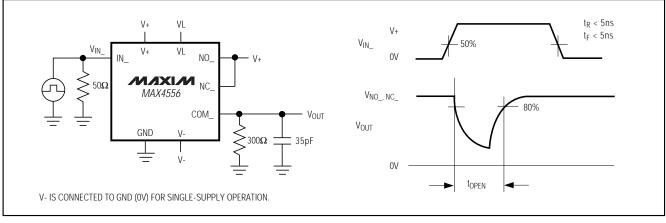


Figure 12. Break-Before-Make Interval

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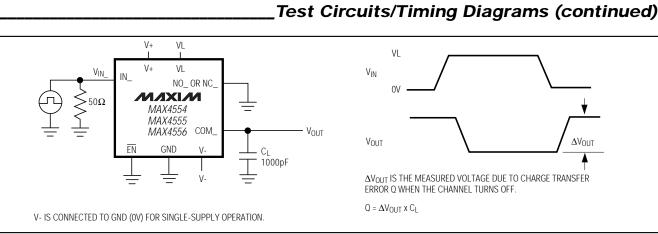


Figure 13. Charge Injection

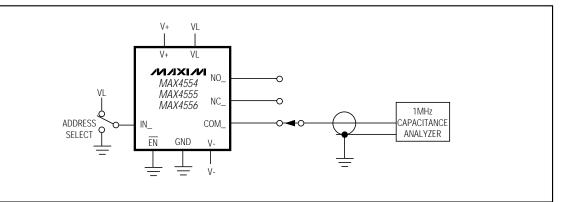


Figure 14. COM\_, NO\_, NC\_ Capacitance

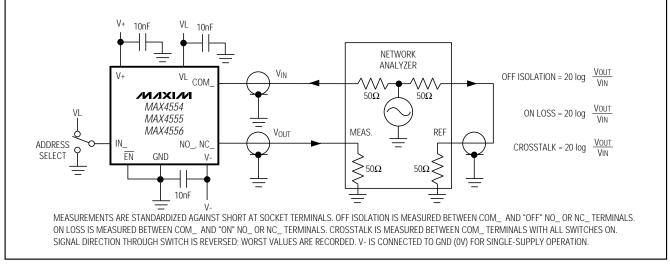
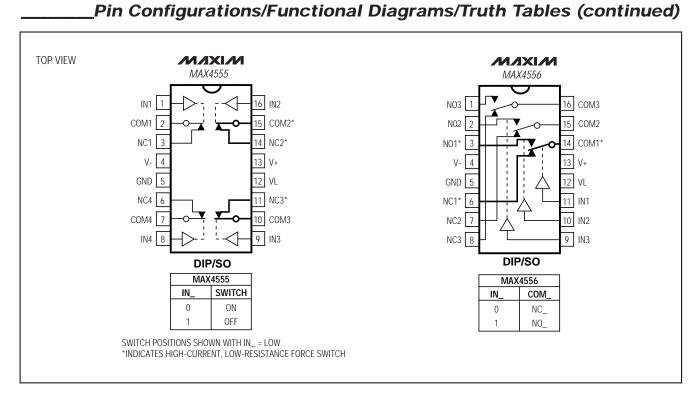


Figure 15. Frequency Response, Off-Isolation, and Crosstalk





# afigurations/Europtional Disgrams/Truth Tables (sentinued)

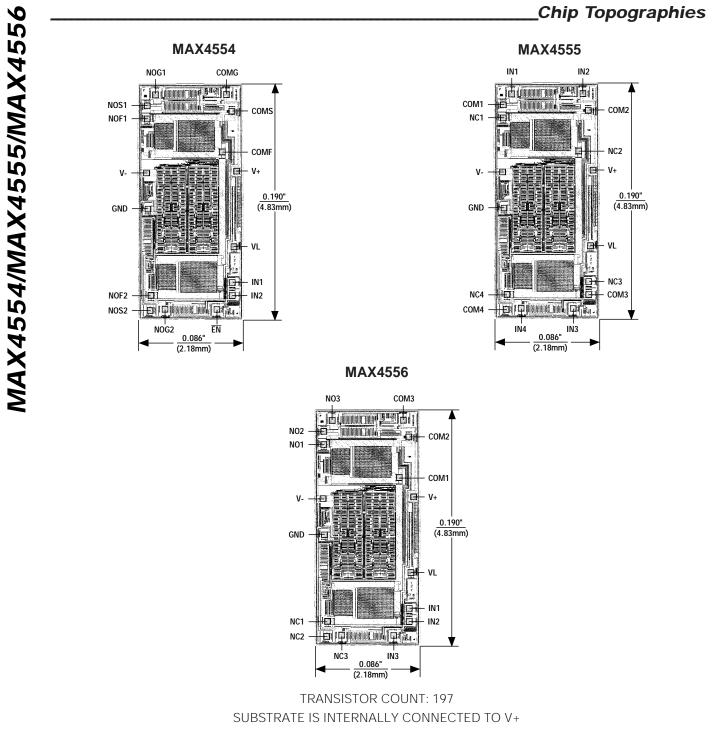
**Force-Sense Switches** 

# Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE
MAX4555CPE	0°C to +70°C	16 Plastic DIP
MAX4555CSE	0°C to +70°C	16 Narrow SO
MAX4555C/D	0°C to +70°C	Dice*
MAX4555EPE	-40°C to +85°C	16 Plastic DIP
MAX4555ESE	-40°C to +85°C	16 Narrow SO
MAX4556CPE	0°C to +70°C	16 Plastic DIP
MAX4556CSE	0°C to +70°C	16 Narrow SO
MAX4556C/D	0°C to +70°C	Dice*
MAX4556EPE	-40°C to +85°C	16 Plastic DIP
MAX4556ESE	-40°C to +85°C	16 Narrow SO

\* Contact factory for availability.

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